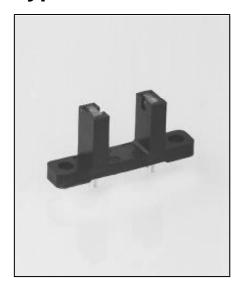


Deep Gap Slotted Optical Switch Type OPB815L

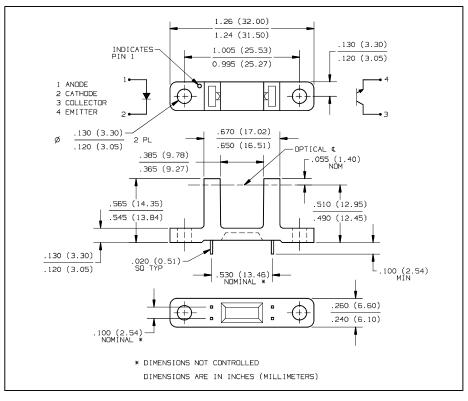


Features

- Non-contact switching
- · Printed circuit board mounting
- 0.375" (9.53 mm) wide slot
- 0.430" (10.92 mm) deep slot

Description

The OPB815L consists of an infrared emitting diode and an NPN silicon phototransistor mounted in a low cost plastic housing on opposite sides of a 0.375" (9.53 mm) wide, 0.430" (10.92 mm) deep slot. Phototransistor switching takes place whenever an opaque object passes through the slot. Available with wire leads as OPB815W.



Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

- (1) RMA flux is recommended. Duration can be extended to 10 sec. max when flow soldering.
- (2) Derate linearly 1.67 mW/° C above 25° C.
- (3) Methanol or isopropanol are recommended as cleaning agents. Plastic housing is soluble in chlorinated hydrocarbons and ketones.
- (4) All parameters tested using pulse technique.

Type OPB815L

Electrical Characteristics (T_A = 25° C unless otherwise noted)

SYMBOL	PARAMETER	MIN	MAX	UNITS	TEST CONDITIONS
Input Diode					
VF	Forward Voltage		1.70	V	I _F = 20 mA
I _R	Reverse Current		100	μΑ	V _R = 2.0 V
Output Phototransistor					
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	30		V	I _C = 1.00 mA
V _{(BR)ECO}	Emitter-Collector Breakdown Voltage	5.0		V	I _E = 100 μA
I _{CEO}	Collector-Emitter Dark Current		100	nA	V _{CE} = 10.0 V, I _F = 0, E _e = 0
Coupled					
V _{CE(SAT)}	Collector-Emitter Saturation Voltage		0.40	V	$I_C = 500 \mu\text{A}, \ I_F = 20 \text{mA}$
I _{C(ON)}	On-State Collector Current	3.5	16.0	mA	V _{CE} = 10.0 V, I _F = 20 mA

Typical Performance Curves

Collector Current vs LED Drive

